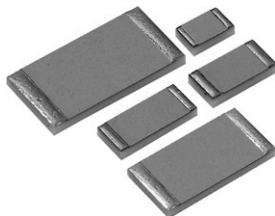


Ultra High Precision Z-Foil Flip Chip Resistor with TCR of ± 0.05 ppm/°C, 35 % Space Saving vs. Wraparound Design and PCR of 5 ppm at Rated Power



Bottom View

INTRODUCTION

One of the most important parameters influencing stability is the temperature coefficient of resistance (TCR). Although the TCR of Bulk Metal® Foil resistors is considered extremely low, this characteristic has been further refined over the years.

The VFCP Series utilizes ultra precision Bulk Metal® Z-Foil.

The Z-Foil technology provides a significant reduction to the resistive element's sensitivity to ambient temperature variations (TCR) and to self heating when power is applied (power coefficient).

Along with the inherently low PCR and TCR, Z-Foil technology also provides remarkably improved load life stability, low noise and availability of tight tolerance.

The flip chip configuration provides a substantial PCB space saving of more than 35 % vs. a surface mount chip with wraparound terminations. The VFCP is available in any value within the specified resistance range.

Our application engineering department is available to advise and make recommendations. For non-standard technical requirements and special applications, please contact us.

TABLE 1 - TOLERANCE AND TCR VS. RESISTANCE VALUE

RESISTANCE VALUE (Ω)	TOLERANCE (%)	TYPICAL TCR AND MAX. SPREAD (- 55 °C to + 125 °C, + 25 °C Ref.)
250 to 125K	± 0.01	± 0.2 ± 1.6
100 to < 250	± 0.02	± 0.2 ± 1.6
50 to < 100	± 0.05	± 0.2 ± 1.8
25 to < 50	± 0.1	± 0.2 ± 2.8
10 to < 25	± 0.25	± 0.2 ± 2.8

FEATURES

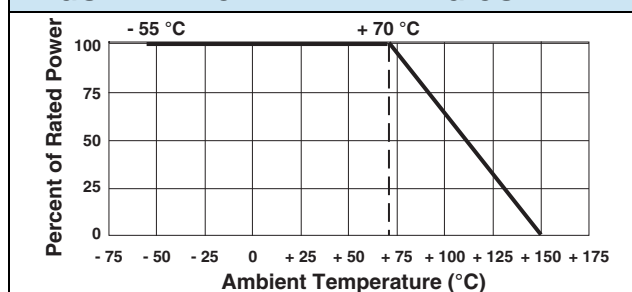
- Temperature coefficient of resistance (TCR):
± 0.05 ppm/°C typical (0 °C to + 60 °C)
± 0.2 ppm/°C typical (- 55 °C to + 125 °C, + 25 °C ref.)
- Tolerance: to ± 0.01 % (100 ppm)
- Power coefficient "ΔR due to self heating"
5 ppm at rated power
- Load life stability (70 °C for 2000 h): ± 0.005 % (50 ppm)
- Power rating to: 600 mW at + 70 °C
- Electrostatic discharge (ESD) up to 25 000 V
- Resistance range: 10 Ω to 125 kΩ (for lower and higher values, please contact us)
- Foil resistors are not restricted to standard values; specific "as required" values can be supplied at no extra cost or delivery (e.g. 1K2345 vs. 1K)
- Non-inductive, non-capacitive design
- Short time overload ≤ 0.005 % (50 ppm)
- Non hot spot design
- Rise time: 1 ns effectively no ringing
- Current noise: - 40 dB
- Voltage coefficient < 0.1 ppm/V
- Non-inductive: < 0.08 μH
- Terminal finishes available: lead (Pb)-free, tin/lead alloy
- Compliant to RoHS directive 2002/95/EC
- Matched sets are available per request
- Prototype quantities available in just 5 working days or sooner. For more information, please contact foil@vishaypg.com
- For better performances please contact us



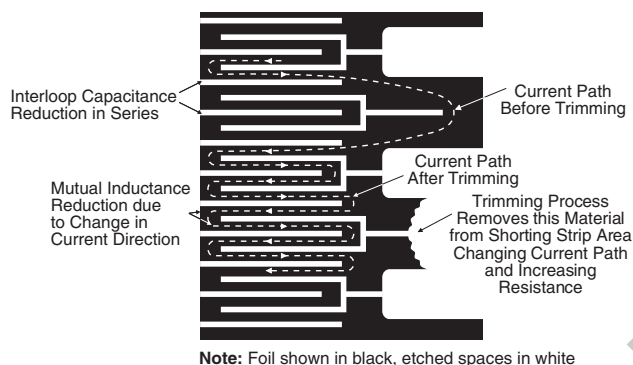
APPLICATIONS

- Automatic test equipment (ATE)
- High precision instrumentation
- Laboratory, industrial and medical
- Audio
- EB applications (electron beam scanning and recording equipment, electron microscopes)
- Military and space
- Airborne
- Down hole instrumentation
- Communication

FIGURE 1 - POWER DERATING CURVE



* Pb containing terminations are not RoHS compliant, exemptions may apply

FIGURE 2 - TRIMMING TO VALUES (Conceptual Illustration)**TABLE 2 - SPECIFICATIONS**

CHIP SIZE	RATED POWER (mW) at + 70 °C	MAXIMUM VOLTAGE RATING ($\leq \sqrt{P \times R}$)	RESISTANCE RANGE (Ω)	MAXIMUM WEIGHT (mg)
0805	100 mW	28 V	10 to 8K	5.2
1206	250 mW	79 V	10 to 25K	10.3
1506	300 mW	95 V	10 to 30K	12
2010	400 mW	167 V	10 to 70K	25
2512	600 mW	220 V	10 to 125K	35

TABLE 3 - LOAD LIFE STABILITY
(+ 70 °C for 2000 h)

CHIP SIZE	MAXIMUM ΔR LIMITS
0805	$\pm 0.005\%$ at 50 mW $\pm 0.01\%$ at 100 mW
1206	$\pm 0.005\%$ at 150 mW $\pm 0.01\%$ at 250 mW
1506	$\pm 0.005\%$ at 150 mW $\pm 0.01\%$ at 300 mW
2010	$\pm 0.005\%$ at 200mW $\pm 0.01\%$ at 400 mW
2512	$\pm 0.005\%$ at 500 mW $\pm 0.01\%$ at 600 mW

TABLE 4 - PERFORMANCES

TEST OR CONDITION	MIL-PRF-55342 CHARACTERISTIC E ΔR LIMITS	TYPICAL ΔR LIMITS	MAXIMUM ΔR LIMITS ⁽¹⁾
Thermal Shock	$\pm 0.1\%$	$\pm 0.005\%$ (50 ppm)	$\pm 0.01\%$ (100 ppm)
Low Temperature Operation	$\pm 0.1\%$	$\pm 0.005\%$ (50 ppm)	$\pm 0.01\%$ (100 ppm)
Short Time Overload	$\pm 0.1\%$	$\pm 0.005\%$ (50 ppm)	$\pm 0.01\%$ (100 ppm)
High Temperature Exposure	$\pm 0.1\%$	$\pm 0.01\%$ (100 ppm)	$\pm 0.02\%$ (200 ppm)
Resistance to Soldering Heat	$\pm 0.2\%$	$\pm 0.005\%$ (50 ppm)	$\pm 0.015\%$ (150 ppm)
Moisture Resistance	$\pm 0.2\%$	$\pm 0.005\%$ (50 ppm)	$\pm 0.02\%$ (200 ppm)
Load Life Stability + 70 °C for 2000 hours at Rated Power	$\pm 0.5\%$	$\pm 0.005\%$ (50 ppm)	$\pm 0.01\%$ (100 ppm)

Note

⁽¹⁾ As shown + 0.01 W to allow for measurement errors at low values.

TABLE 5 - DIMENSIONS AND LAND PATTERN in inches (millimeters)

BOTTOM VIEW (showing terminals for mounting)				LAND PATTERN			
CHIP SIZE	L ± 0.005 (0.13)	W ± 0.005 (0.13)	THICKNESS MAXIMUM	D ± 0.005 (0.13)	Z	G	X
0805	0.079 (2.01)	0.049 (1.24)	0.025 (0.64)	0.010 (0.25)	0.078 (1.98)	0.053 (1.35)	0.049 (1.24)
1206	0.126 (3.20)	0.062 (1.57)	0.025 (0.64)	0.015 (0.38)	0.125 (3.18)	0.090 (2.29)	0.062 (1.57)
1506	0.150 (3.81)	0.062 (1.57)	0.025 (0.64)	0.012 (0.30)	0.150 (3.81)	0.120 (3.05)	0.062 (1.57)
2010	0.200 (5.08)	0.100 (2.54)	0.025 (0.64)	0.020 (0.51)	0.199 (5.05)	0.153 (3.89)	0.100 (2.54)
2512	0.250 (6.35)	0.126 (3.20)	0.025 (0.64)	0.024 (0.61)	0.250 (6.35)	0.196 (4.98)	0.126 (3.20)

Notes

- Avoid the use of cleaning agents which could attack epoxy resins, which form part of the resistor construction
- Vacuum pick up is recommended for handling
- Soldering iron is not applicable

FIGURE 3 - CHIP CONFIGURATION

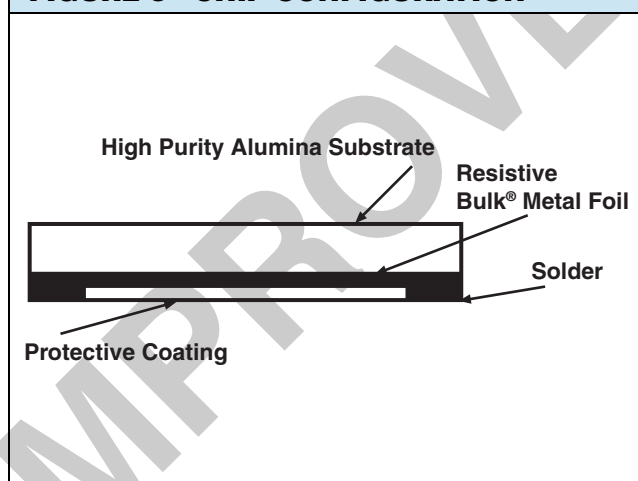
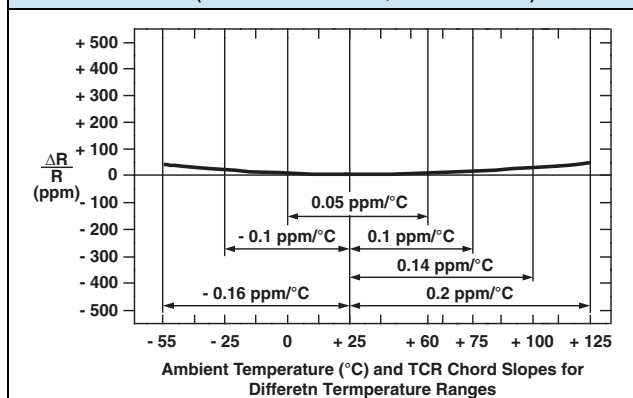


FIGURE 4 - TYPICAL RESISTANCE/TEMPERATURE CURVE
(for more details, see table 1)

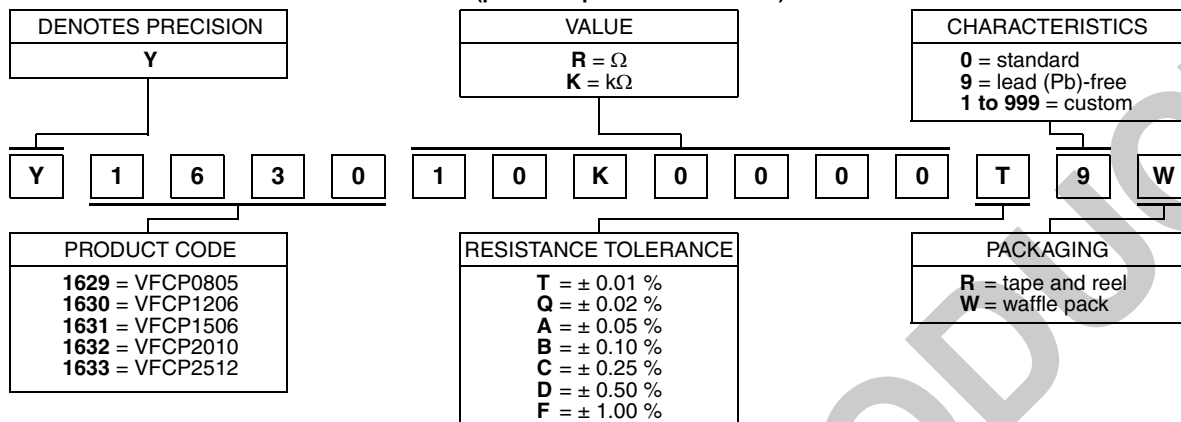


Note

- The TCR values for $< 100 \Omega$ are influenced by the termination composition and result in deviation from this curve

TABLE 6 - GLOBAL PART NUMBER INFORMATION ⁽¹⁾

NEW GLOBAL PART NUMBER: Y163010K000T9W (preferred part number format)



FOR EXAMPLE: ABOVE GLOBAL ORDER Y1630 10K0000 T 9 W:

TYPE: VFCP1206

VALUE: 10.0 $k\Omega$

ABSOLUTE TOLERANCE: $\pm 0.01\%$

TERMINATION: lead (Pb)-free

PACKAGING: waffle pack

HISTORICAL PART NUMBER: VFCP1206 10K000 TCR0.2 T S W (will continue to be used)

VFCP1206	10K000	TCR0.2	T	S	W
MODEL	OHMIC VALUE	TCR	RESISTANCE TOLERANCE	TERMINATION	PACKAGING
VFCP0805 VFCP1206 VFCP1506 VFCP2010 VFCP2512	10.0 $k\Omega$	Characteristic	T = $\pm 0.01\%$ Q = $\pm 0.02\%$ A = $\pm 0.05\%$ B = $\pm 0.10\%$ C = $\pm 0.25\%$ D = $\pm 0.50\%$ F = $\pm 1.00\%$	S = lead (Pb)-free B = tin/lead	T = tape and reel W = waffle pack

Note

⁽¹⁾ For non-standard requests, please contact application engineering.

Disclaimer

ALL PRODUCTS, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE.

Vishay Precision Group, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay Precision Group"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

The product specifications do not expand or otherwise modify Vishay Precision Group's terms and conditions of purchase, including but not limited to, the warranty expressed therein.

Vishay Precision Group makes no warranty, representation or guarantee other than as set forth in the terms and conditions of purchase. **To the maximum extent permitted by applicable law, Vishay Precision Group disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.**

Information provided in datasheets and/or specifications may vary from actual results in different applications and performance may vary over time. Statements regarding the suitability of products for certain types of applications are based on Vishay Precision Group's knowledge of typical requirements that are often placed on Vishay Precision Group products. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application.

No license, express, implied, or otherwise, to any intellectual property rights is granted by this document, or by any conduct of Vishay Precision Group.

The products shown herein are not designed for use in life-saving or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay Precision Group products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay Precision Group for any damages arising or resulting from such use or sale. Please contact authorized Vishay Precision Group personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9